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## BIB DATA SHEET

CONFIRMATION NO. 1077

SERIAL NUMBER	FILING or 371(c) DATE RULE	CLASS	GROUP ART UNIT	ATTORNEY DOCKET NO.
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## APPLICANTS

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## \*\* CONTINUING DATA \*\*\*\*\*

This application is a 371 of PCT/JP04/12633 09/01/2004  /SJN/

## \*\* FOREIGN APPLICATIONS \*\*\*\*\*

JAPAN 2003-309239 09/01/2003  /SJN/

## \*\* IF REQUIRED, FOREIGN FILING LICENSE GRANTED \*\*

05/05/2008

Foreign Priority claimed	<input checked="" type="checkbox"/> Yes <input type="checkbox"/> No	<input type="checkbox"/> Met after Allowance /SJN/	STATE OR COUNTRY	SHEETS DRAWINGS	TOTAL CLAIMS	INDEPENDENT CLAIMS
35 USC 119(a-d) conditions met	<input checked="" type="checkbox"/> Yes <input type="checkbox"/> No		JAPAN	3	6	1
Verified and Acknowledged	/SEAHVOSH J NIKMANESH/ Examiner's Signature	Initials				

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## TITLE

Method for Manufacturing Bonded Wafer

FILING FEE RECEIVED 900	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees
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